



General Purpose Transistors

NPN Silicon



MAXIMUM RATINGS

Rating	Symbol	BC847 BC848			Unit
		BC846	BC850	BC849	
Collector-Emitter Voltage	V_{CEO}	65	45	30	V
Collector-Base Voltage	V_{CBO}	80	50	30	V
Emitter-Base Voltage	V_{EBO}	6.0	6.0	5.0	V
Collector Current — Continuous	I_C	100	100	100	mAdc
Collector Current(Peak value)	I_{CM}	200	200	200	mAdc
Emitter Current(Peak value)	I_{EM}	200	200	200	mAdc
Base Current(Peak value)	I_{BM}	200	200	200	mAdc

SOLDERING CHARACTERISTICS

Characteristic	Symbol	Unit
Solder Heat Resistance	265	°C
Solderability	240 to 265	°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Total Device Dissipation FR-5 Board, (1)	P_D		
$T_A = 25^\circ\text{C}$		225	mW
Derate above 25°C		1.8	mW/°C
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	556	°C/W
Total Device Dissipation	P_D		
Alumina Substrate, (2) $T_A = 25^\circ\text{C}$		300	mW
Derate above 25°C		2.4	mW/°C
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	417	°C/W
Junction and Storage Temperature	T_J, T_{stg}	-55 to +150	°C

DEVICE MARKING

BC846= 1A; BC846B = 1B; BC847A = 1E; BC847B = 1F;
BC847C= 1G; BC848A= 1J; BC848B= 1K; BC848C= 1L; BC850C= 2G

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
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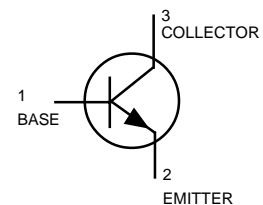
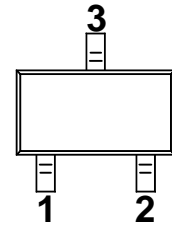
OFF CHARACTERISTICS

Collector-Emitter Breakdown Voltage ($I_C = 10\text{ mA}$)	BC846A,B	65	—	—	
	BC847A,B,C, BC850B,C	$V_{(BR)CEO}$ 45	—	—	v
	BC848A,B,C, BC849B,C	30	—	—	
Collector-Emitter Breakdown Voltage ($I_C = 10\text{ }\mu\text{A}$, $V_{EB} = 0$)	BC846A,B	80	—	—	
	BC847A,B,C, BC850B,C	$V_{(BR)CES}$ 50	—	—	v
	BC848A,B,C, BC849B,C	30	—	—	
Collector-Base Breakdown Voltage ($I_C = 10\text{ }\mu\text{A}$)	BC846A,B	80	—	—	
	BC847A,B,C, BC850B,C	$V_{(BR)CBO}$ 50	—	—	v
	BC848A,B,C, BC849B,C	30	—	—	
Emitter-Base Breakdown Voltage ($I_E = 1.0\text{ }\mu\text{A}$)	BC846A,B	6.0			
	BC847A,B,C				
	BC848A,B,C, BC849B,C, BC850B,C	$V_{(BR)EBO}$ 5.0			
Collector Cutoff Current ($V_{CB} = 30\text{ V}$)		I_{CBO} —	—	15	nA
	($V_{CB} = 30\text{ V}$, $T_A = 150^\circ\text{C}$)		—	5.0	μA

1. FR-5 = 1.0 x 0.75 x 0.062 in

2. Alumina = 0.4 x 0.3 x 0.024 in. 99.5% alumina.

SOT-23 (TO-236AB)



DEVICE CHARACTERISTICS

BC846 THRU BC850

ELECTRICAL CHARACTERISTICS($T_A = 25^\circ\text{C}$ unless otherwise noted) (Continued)

Characteristic	Symbol	Min	Typ	Max	Unit
ON CHARACTERISTICS					
DC Current Gain ($I_C = 10\ \mu\text{A}$, $V_{CE} = 5.0\ \text{V}$)	h_{FE}	—	90	—	—
		—	150	—	—
		—	270	—	—
($I_C = 2.0\ \text{mA}$, $V_{CE} = 5.0\ \text{V}$)		110	180	220	
		200	290	450	
		420	520	800	
Collector-Emitter Saturation Voltage ($I_C = 10\ \text{mA}$, $I_B = 0.5\ \text{mA}$) ($I_C = 100\ \text{mA}$, $I_B = 5.0\ \text{mA}$)	$V_{CE(sat)}$	—	—	0.25 0.6	V
Base-Emitter Saturation Voltage ($I_C = 10\ \text{mA}$, $I_B = 0.5\ \text{mA}$) ($I_C = 100\ \text{mA}$, $I_B = 5.0\ \text{mA}$)	$V_{BE(sat)}$	—	0.7 0.9	—	V
Base-Emitter Voltage ($I_C = 2.0\ \text{mA}$, $V_{CE} = 5.0\ \text{V}$) ($I_C = 10\ \text{mA}$, $V_{CE} = 5.0\ \text{V}$)	$V_{BE(on)}$	580	660	700 770	mV

SMALL-SIGNAL CHARACTERISTICS

Current-Gain — Bandwidth Product ($I_C = 10\ \text{mA}$, $V_{CE} = 5.0\ \text{Vdc}$, $f = 100\ \text{MHz}$)	f_T	100	—	—	MHz
Output Capacitance ($V_{CB} = 10\ \text{V}$, $f = 1.0\ \text{MHz}$)	C_{obo}	—	—	4.5	pF
Noise Figure ($I_C = 0.2\ \text{mA}$, BC846A, BC847A, BC848A $V_{CE} = 5.0\ \text{Vdc}$, $R_S = 2.0\ \text{k}\Omega$, BC846B, BC847B, BC848B $f = 1.0\ \text{kHz}$, BW = 200 Hz) BC847C, BC848C BC849B,C, BC850B,C	NF	—	—	10 4.0	dB

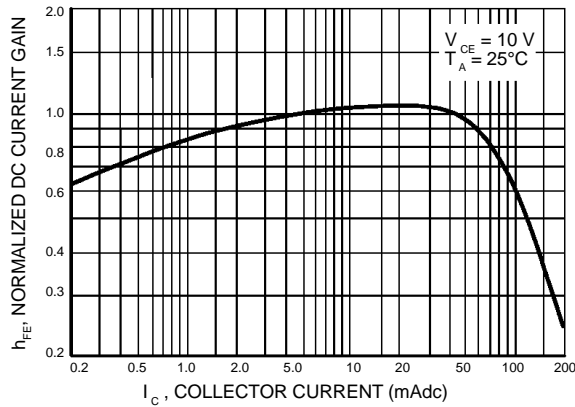


Figure 1. Normalized DC Current Gain

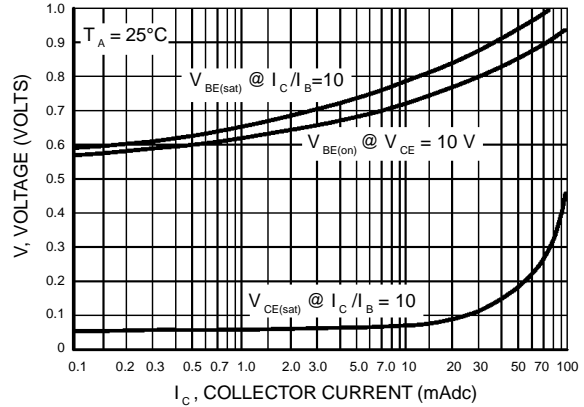


Figure 2. "Saturation" and "On" Voltages

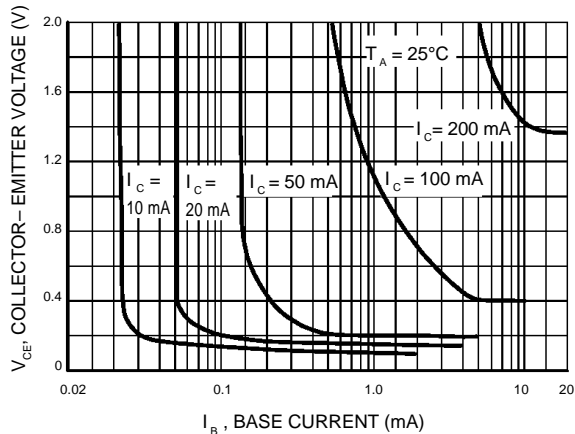


Figure 3. Collector Saturation Region

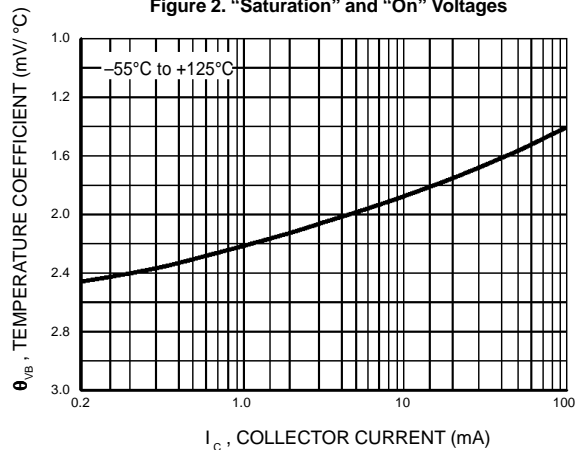


Figure 4. Base-Emitter Temperature Coefficient

DEVICE CHARACTERISTICS

BC846 THRU BC850

BC847/BC848

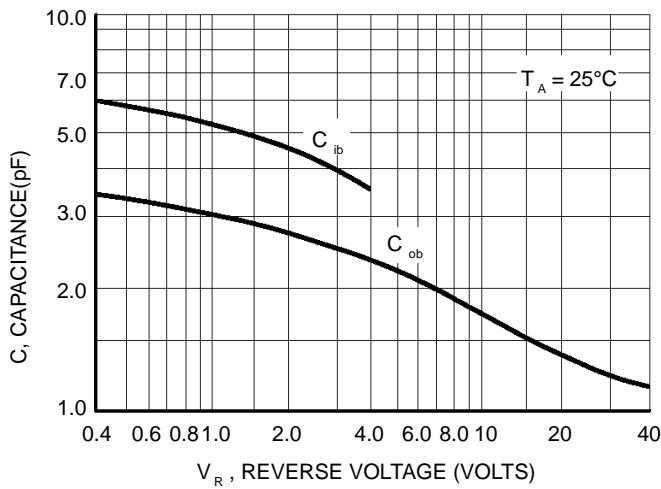


Figure 5. Capacitances

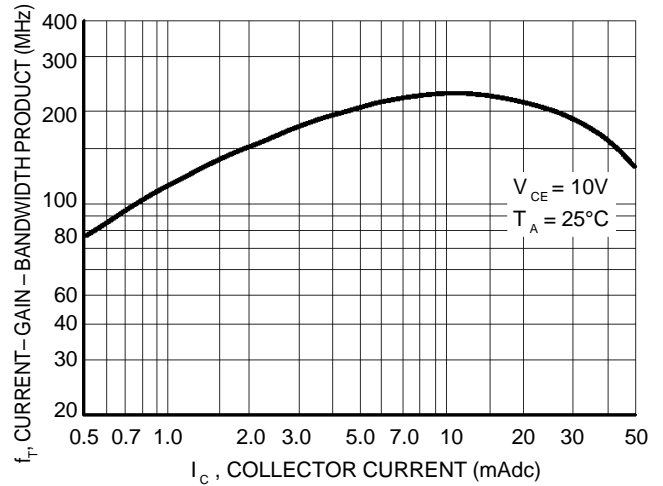


Figure 6. Current-Gain - Bandwidth Product

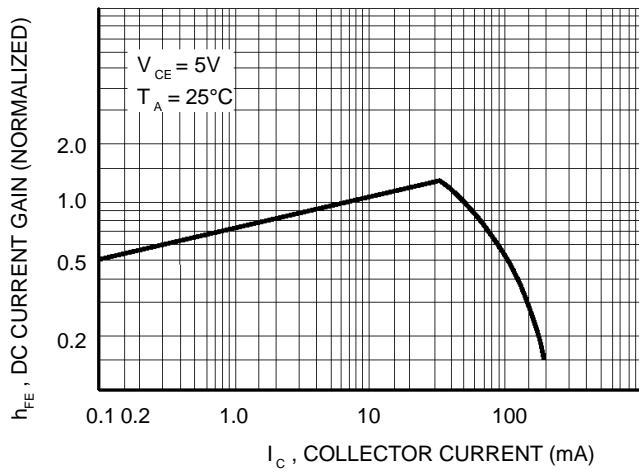


Figure 7. DC Current Gain

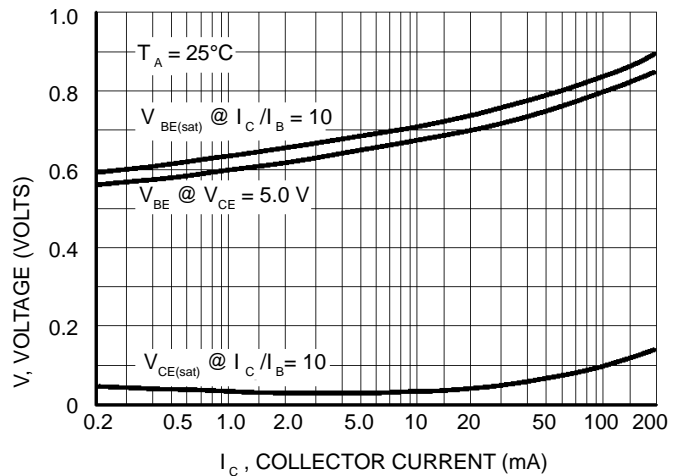


Figure 8. "On" Voltage

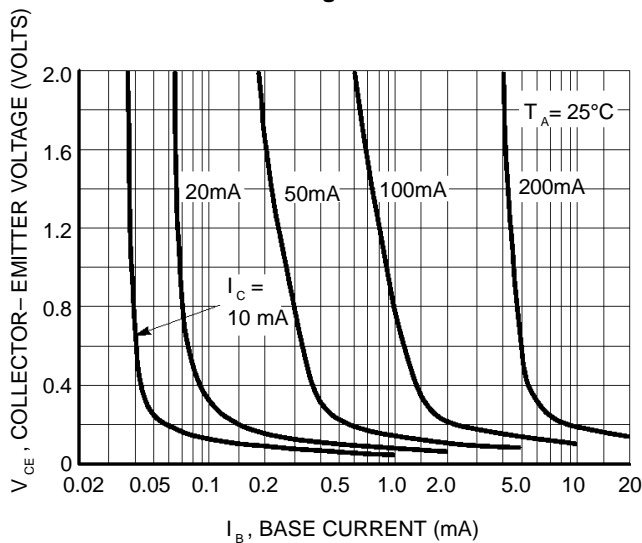


Figure 9. Collector Saturation Region

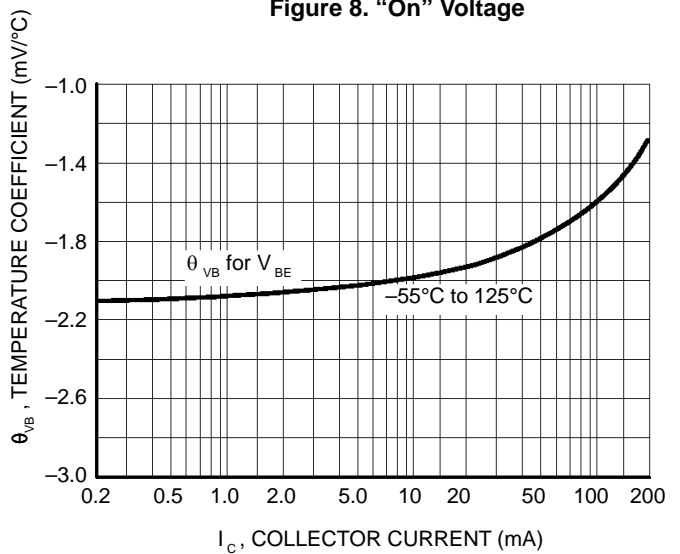


Figure 10. Base-Emitter Temperature Coefficient

DEVICE CHARACTERISTICS

BC846 THRU BC850

BC846

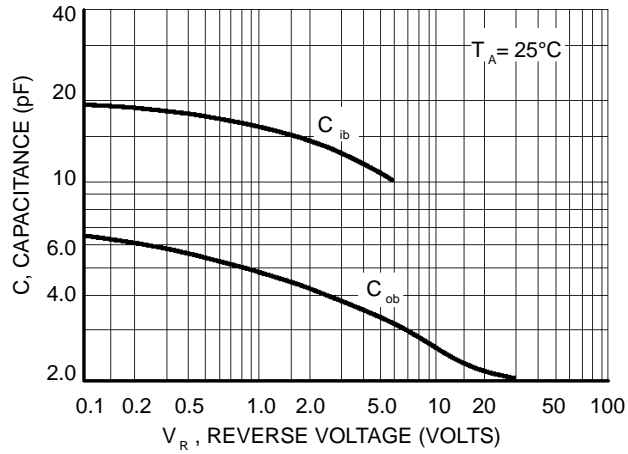


Figure 11. Capacitance

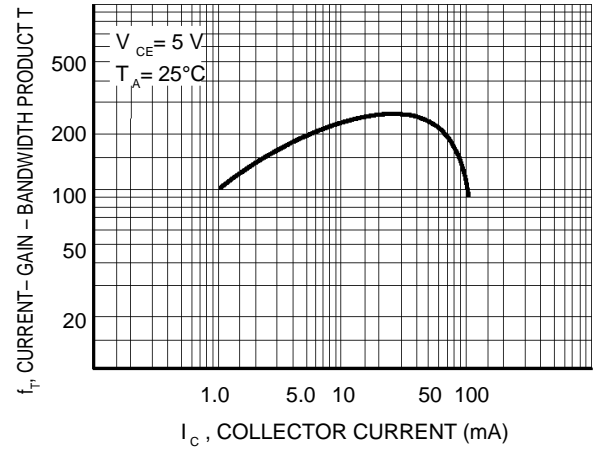


Figure 12. Current-Gain - Bandwidth Product

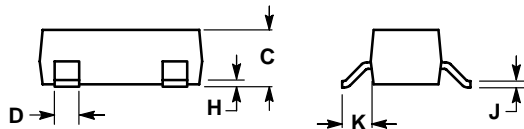
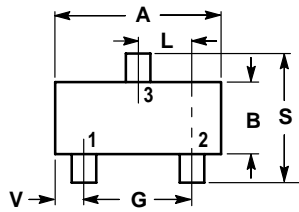
PACKAGE OUTLINE & DIMENSIONS

BC846 THRU BC850

SOT-23

NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982
2. CONTROLLING DIMENSION: INCH.



DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.1102	0.1197	2.80	3.04
B	0.0472	0.0551	1.20	1.40
C	0.0350	0.0440	0.89	1.11
D	0.0150	0.0200	0.37	0.50
G	0.0701	0.0807	1.78	2.04
H	0.0005	0.0040	0.013	0.100
J	0.0034	0.0070	0.085	0.177
K	0.0140	0.0285	0.35	0.69
L	0.0350	0.0401	0.89	1.02
S	0.0830	0.1039	2.10	2.64
V	0.0177	0.0236	0.45	0.60

